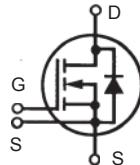


HiPerFET™ Power MOSFETs Single Die MOSFET

IXFN 34N100

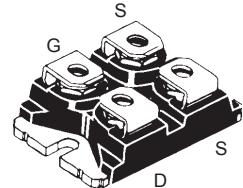
V_{DSS} = 1000V
I_{D25} = 34A
R_{DS(on)} = 0.28Ω

N-Channel Enhancement Mode
 Avalanche Rated, High dv/dt, Low t_{rr}



| Symbol | Test Conditions | Maximum Ratings | | |
|-------------------|--|-------------------|-----------|-------|
| V _{DSS} | T _J = 25°C to 150°C | 1000 | V | |
| V _{DGR} | T _J = 25°C to 150°C; R _{GS} = 1 MΩ | 1000 | V | |
| V _{GS} | Continuous | ±20 | V | |
| V _{GSM} | Transient | ±30 | V | |
| I _{D25} | T _C = 25°C, Chip capability | 34 | A | |
| I _{DM} | T _C = 25°C, pulse width limited by T _{JM} | 136 | A | |
| I _{AR} | T _C = 25°C | 34 | A | |
| E _{AR} | T _C = 25°C | 64 | mJ | |
| E _{AS} | T _C = 25°C | 4 | J | |
| dv/dt | I _S ≤ I _{DM} , di/dt ≤ 100 A/μs, V _{DD} ≤ V _{DSS} , T _J ≤ 150°C, R _G = 2 Ω | 5 | V/ns | |
| P _D | T _C = 25°C | 700 | W | |
| T _J | | -55 ... +150 | °C | |
| T _{JM} | | 150 | °C | |
| T _{stg} | | -55 ... +150 | °C | |
| V _{ISOL} | 50/60 Hz, RMS I _{ISOL} ≤ 1 mA | t = 1 min t = 1 s | 2500 3000 | V~ V~ |
| M _d | Mounting torque | 1.5/13 | Nm/lb.in. | |
| | Terminal connection torque | 1.5/13 | Nm/lb.in. | |
| Weight | | 30 | g | |

miniBLOC, SOT-227 B (IXFN)
 E153432



G = Gate D = Drain
 S = Source TAB = Drain

Either Source terminal at miniBLOC can be used as Main or Kelvin Source

Features

- International standard packages
- miniBLOC, with Aluminium nitride isolation
- Low R_{DS(on)} HDMOS™ process
- Rugged polysilicon gate cell structure
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
- Fast intrinsic Rectifier

Applications

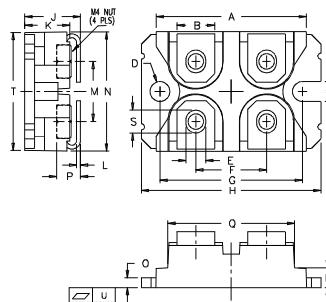
- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls

Advantages

- Easy to mount
- Space savings
- High power density

| Symbol | Test Conditions | Characteristic Values | | |
|---------------------|--|---|------|----------------|
| | | (T _J = 25°C, unless otherwise specified) | min. | typ. |
| V _{DSS} | V _{GS} = 0 V, I _D = 3 mA | 1000 | | V |
| V _{GS(th)} | V _{DS} = V _{GS} , I _D = 8 mA | 3.0 | | 5.5 V |
| I _{GSS} | V _{GS} = ±20 V _{DC} , V _{DS} = 0 | | | ±200 nA |
| I _{DSS} | V _{DS} = V _{DSS} V _{GS} = 0 V | T _J = 25°C T _J = 125°C | | 100 μA 2 mA |
| R _{DS(on)} | V _{GS} = 10 V, I _D = 0.5 • I _{D25} Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 % | | 0.25 | 0.28 Ω |

| Symbol | Test Conditions | Characteristic Values | | | |
|---|--|--|------|------|------|
| | | ($T_J = 25^\circ\text{C}$, unless otherwise specified) | min. | typ. | max. |
| g_{fs} | $V_{DS} = 15 \text{ V}; I_D = 0.5 \cdot I_{D25}$, pulse test | 18 | 40 | S | |
| C_{iss} C_{oss} C_{rss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | 9200 | | pF | |
| | | 1200 | | pF | |
| | | 300 | | pF | |
| $t_{d(on)}$ t_r $t_{d(off)}$ t_f | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$ $R_G = 1 \Omega$ (External), | 41 | | ns | |
| | | 65 | | ns | |
| | | 110 | | ns | |
| | | 30 | | ns | |
| $Q_{g(on)}$ Q_{gs} Q_{gd} | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$ | 380 | | nC | |
| | | 65 | | nC | |
| | | 185 | | nC | |
| R_{thJC} | | | 0.18 | K/W | |
| R_{thCK} | | | 0.05 | K/W | |

miniBLOC, SOT-227 B


M4 screws (4x) supplied

| Dim. | Millimeter | | Inches | |
|------|------------|-------|--------|-------|
| | Min. | Max. | Min. | Max. |
| A | 31.50 | 31.88 | 1.240 | 1.255 |
| B | 7.80 | 8.20 | 0.307 | 0.323 |
| C | 4.09 | 4.29 | 0.161 | 0.169 |
| D | 4.09 | 4.29 | 0.161 | 0.169 |
| E | 4.09 | 4.29 | 0.161 | 0.169 |
| F | 14.91 | 15.11 | 0.587 | 0.595 |
| G | 30.12 | 30.30 | 1.186 | 1.193 |
| H | 38.00 | 38.23 | 1.496 | 1.505 |
| J | 11.68 | 12.22 | 0.460 | 0.481 |
| K | 8.92 | 9.60 | 0.351 | 0.378 |
| L | 0.76 | 0.84 | 0.030 | 0.033 |
| M | 12.60 | 12.85 | 0.496 | 0.506 |
| N | 25.15 | 25.42 | 0.990 | 1.001 |
| O | 1.98 | 2.13 | 0.078 | 0.084 |
| P | 4.95 | 5.97 | 0.195 | 0.235 |
| Q | 26.54 | 26.90 | 1.045 | 1.059 |
| R | 3.94 | 4.42 | 0.155 | 0.174 |
| S | 4.72 | 4.85 | 0.186 | 0.191 |
| T | 24.59 | 25.07 | 0.968 | 0.987 |
| U | -0.05 | 0.1 | -0.002 | 0.004 |

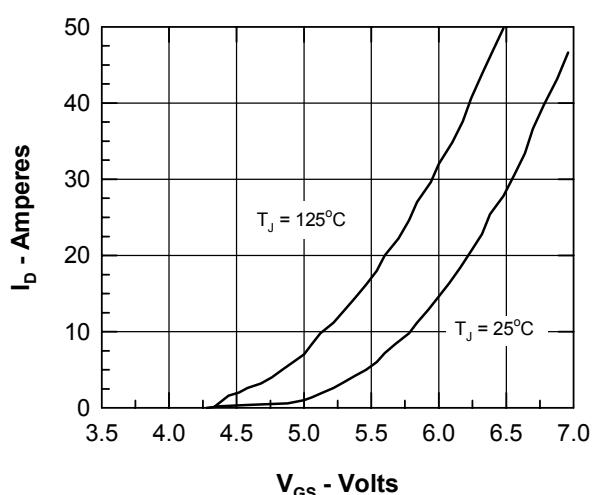
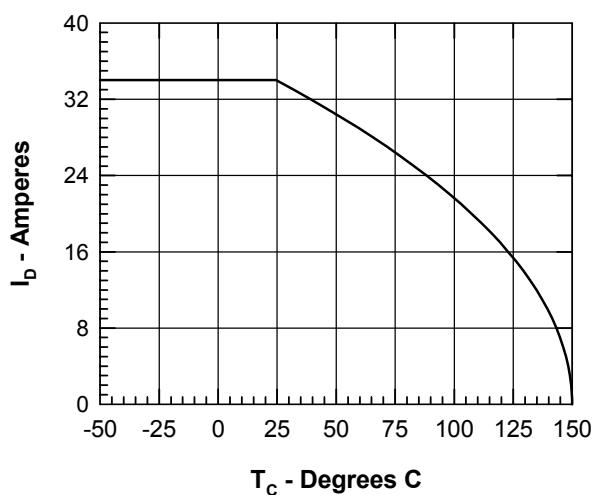
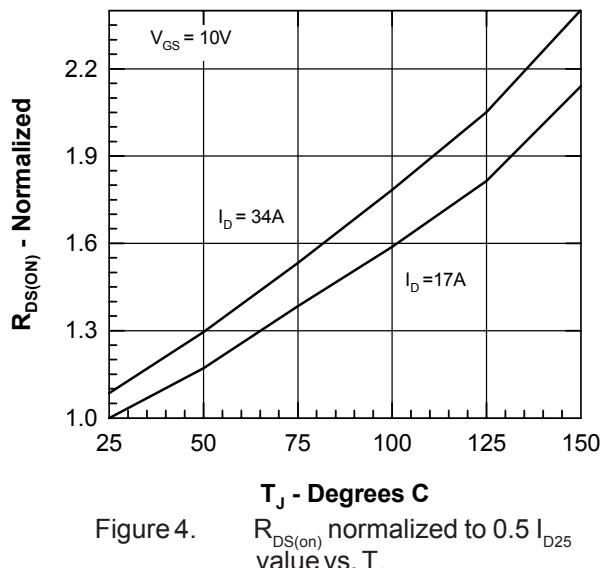
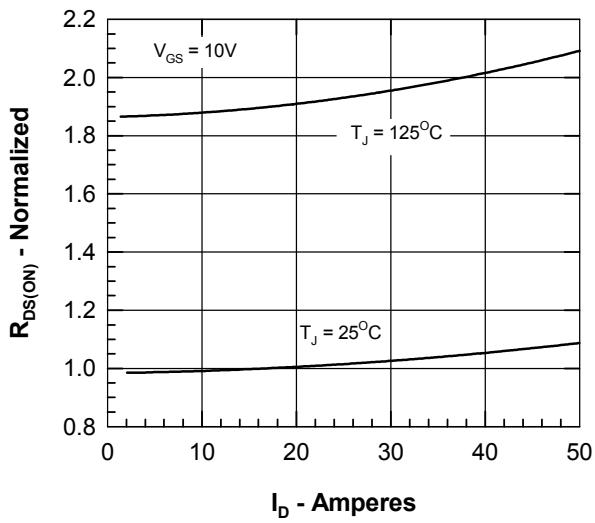
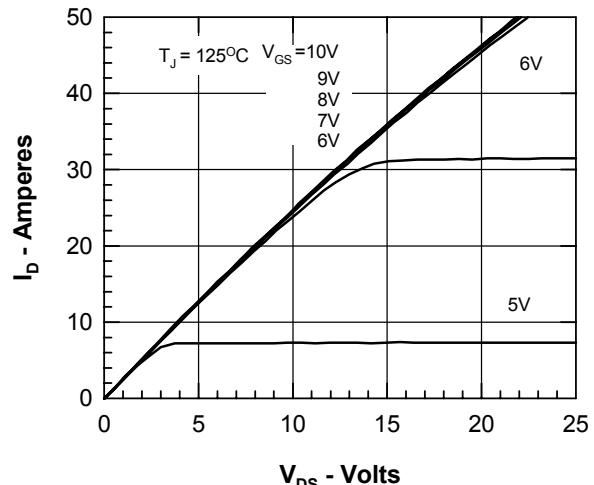
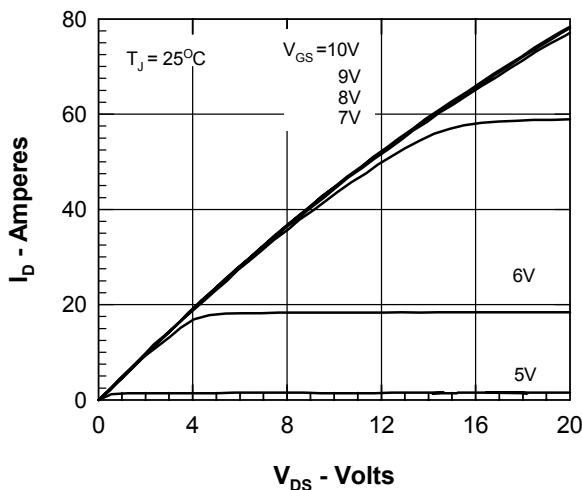
Source-Drain Diode
Characteristic Values
($T_J = 25^\circ\text{C}$, unless otherwise specified)

| Symbol | Test Conditions | min. | typ. | max. |
|----------------------|---|----------------------|------|--------------------------------|
| I_s | $V_{GS} = 0 \text{ V}$ | | 34 | A |
| I_{SM} | Repetitive; pulse width limited by T_{JM} | | 136 | A |
| V_{SD} | $I_F = I_S, V_{GS} = 0 \text{ V}$, Pulse test, $t \leq 300 \mu\text{s}$, duty cycle $d \leq 2 \%$ | | 1.3 | V |
| t_{rr} | $I_F = I_S, -di/dt = 100 \text{ A}/\mu\text{s}, V_R = 100 \text{ V}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ $T_J = 25^\circ\text{C}$ | 180 330 2 8 | | ns ns μC A |
| Q_{RM} I_{RM} | | | | |

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more
of the following U.S. patents:

4,835,592 4,881,106 5,017,508 5,049,961 5,187,117 5,486,715 6,306,728B1 6,259,123B1 6,306,728B1
4,850,072 4,931,844 5,034,796 5,063,307 5,237,481 5,381,025 6,404,065B1 6,162,665 6,534,343



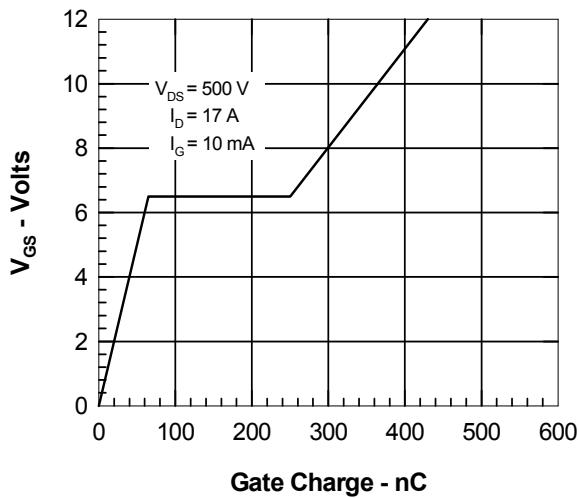


Figure 7. Gate Charge

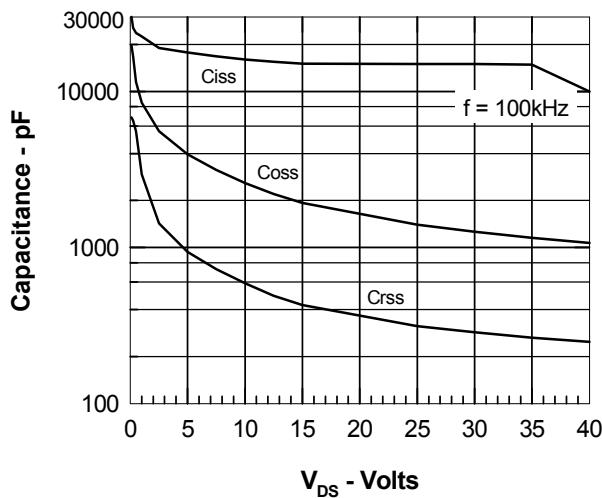


Figure 8. Capacitance Curves

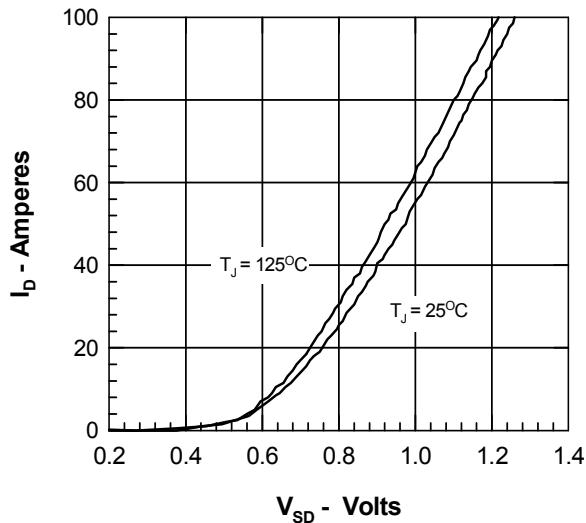


Figure 9. Forward Voltage Drop of the Intrinsic Diode

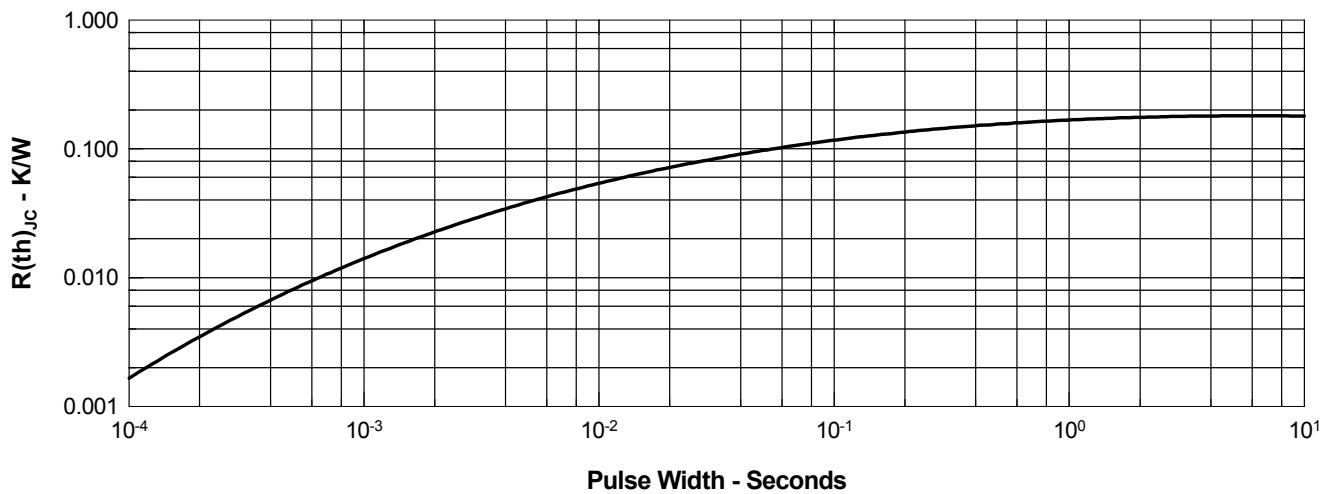


Figure 10. Transient Thermal Resistance

IXYS reserves the right to change limits, test conditions, and dimensions.

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| | | | | | | | | |
|-----------|-----------|-----------|-----------|-----------|-----------|-------------|-------------|-------------|
| 4,835,592 | 4,881,106 | 5,017,508 | 5,049,961 | 5,187,117 | 5,486,715 | 6,306,728B1 | 6,259,123B1 | 6,306,728B1 |
| 4,850,072 | 4,931,844 | 5,034,796 | 5,063,307 | 5,237,481 | 5,381,025 | 6,404,065B1 | 6,162,665 | 6,534,343 |